



CEVA TECHNOLOGY
SYMPOSIUM SERIES

Enabling Intelligent Vision Processing at the Edge

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CEVA

www.ceva-dsp.com





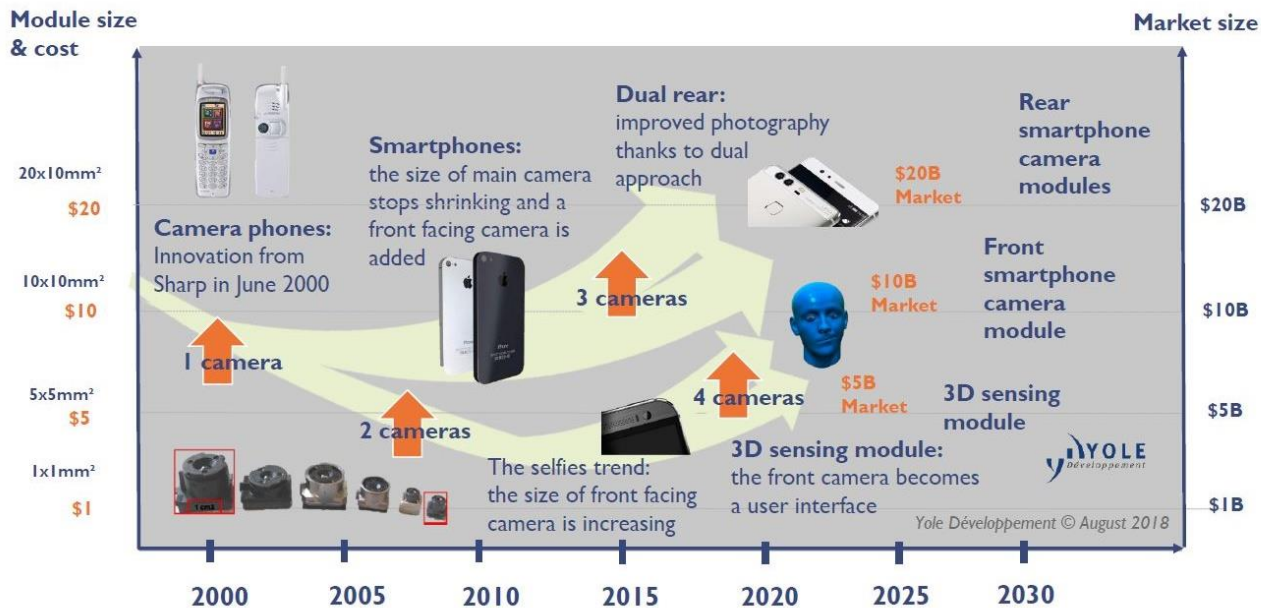
CV Market Trends



Mobile Market Trend

3D brings the fourth camera embedded in smartphones!

Most of the business is for $10 \times 10 \times 5 \text{mm}^3$ camera modules



Smartphone with Four Rear Cameras !

▶ Computational photography features:

- ▶ 2x optical zoom
- ▶ Scene optimizer (19 modes)
- ▶ Manual depth of field adjusting
- ▶ Flaw detection (e.g. Eye Blink, Facial Blur, and backlight issues)
- ▶ And much more...

Samsung
Galaxy A9



- ✓ The camera is still the main highlighted feature
- ✓ There is a need for a better image/video quality

Google Pixel 3 (&2) - Pixel Visual Core

- ▶ Computational photography features:
 - ▶ HDR+, 5 images with 1/10th the power consumption
 - ▶ Complex imaging and machine learning tasks
 - ▶ Super resolution zoom
 - ▶ Night sight

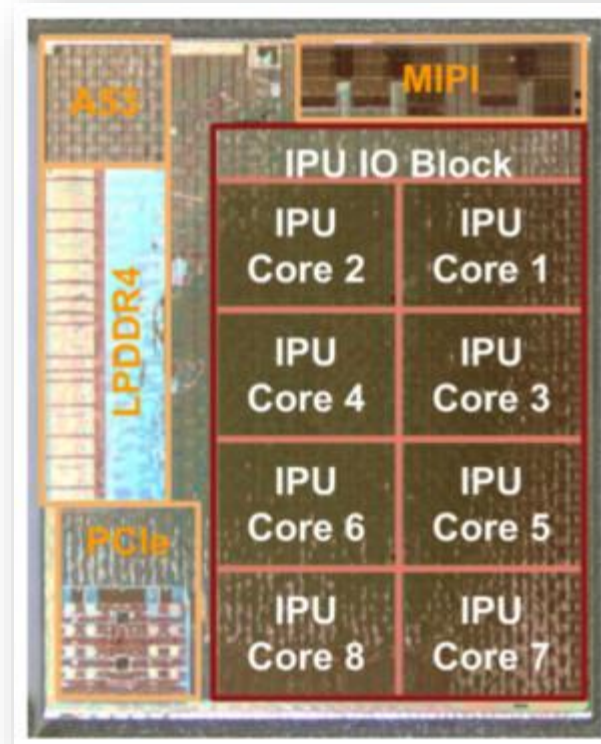
With a single rear camera !



A foreground and background mask created by Google's neural network.



Depth Map data captured using a PDAF camera and the resulting blur map for the final image.



Google Pixel 3 – Night Sight



Allows for incredibly detailed pictures to be captured in low-light situations (without the aid of a flash)

OPPO Find-X - 3D Structured Light Technology



- Global shipments of smartphones featuring 3D sensing technology are expected to top over 100 million units in 2018*
- **Apple** serving as the primary vendor and following by **Xiaomi**, **Oppo** and **Vivo**

(*) according to an estimate of China-based Sigmaintell



Creates a millimeter-scale 3D face depth map for safer unlock

Creates 3D stereo model of the face to perform 3D personality beauty

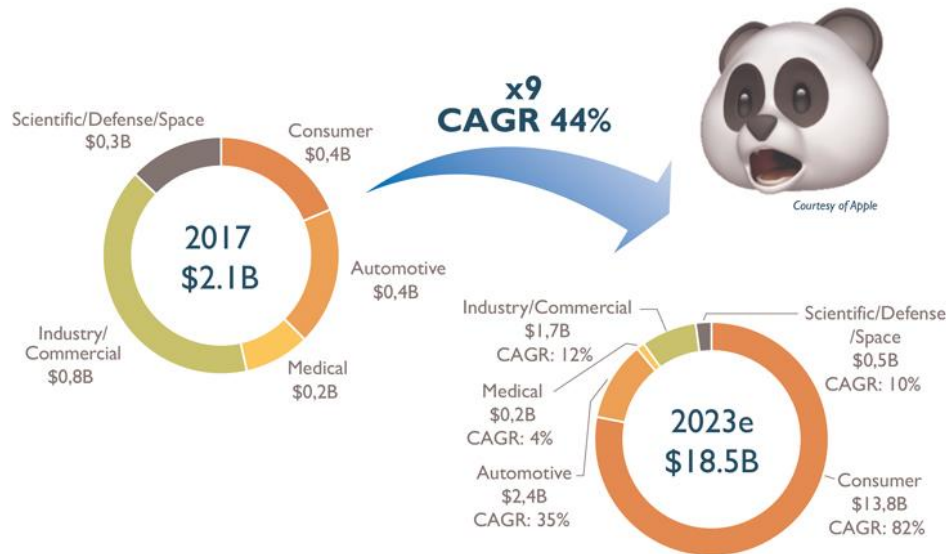
3D Vision Technology

3D vision is a key technology in the fields of human-computer interaction, face recognition, AR/VR, assisted driving, etc.

- Automotive
- Robotics
- 3D Metrology
- Retail
- Security
- Healthcare
- 3D Scanning/Printing
- Gaming
- AR/VR
- Smart Home

3D imaging & sensing revenue breakdown by markets

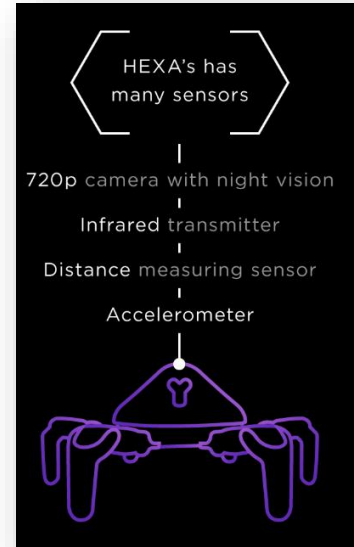
(Source: 3D Imaging & Sensing 2018, Yole Développement, June 2018)



SLAM* (combined with AI)



<https://www.vincross.com/hexa>



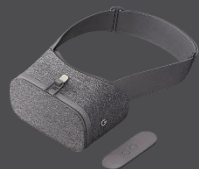
(***) Simultaneous Localization And Mapping**

High Immersion

Cardboard



View-Master



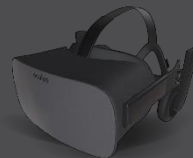
Google Daydream



Samsung Gear



Sony Morpheus



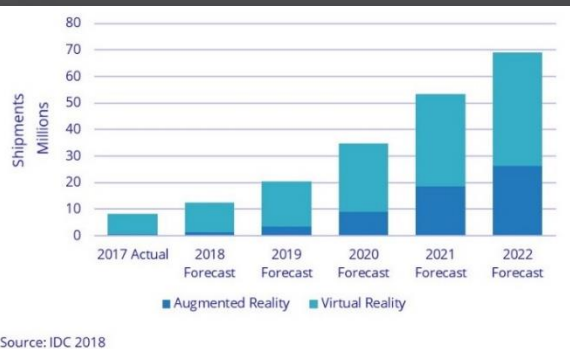
Facebook Oculus



HTC Vive

Inexpensive

Expensive



Low Immersion



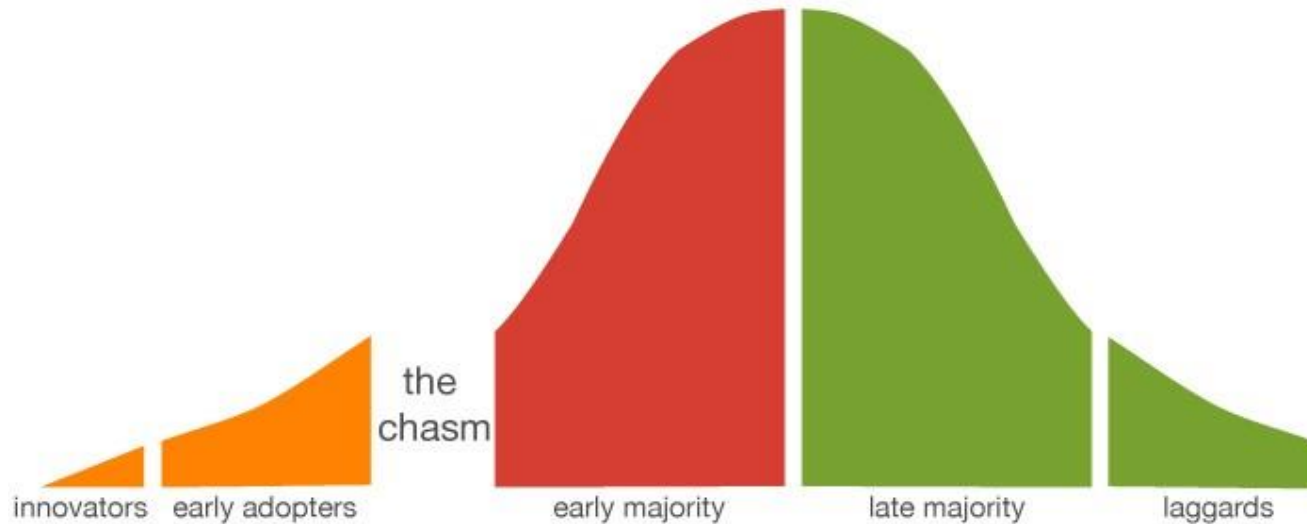
Oculus Quest



Magic Leap One

What do we Need to Make it Happen?

- ▶ VR market faces many challenges
- ▶ What do we need to “cross the chasm”?



Mobile VR Challenges

- ▶ Strong Computing Power
 - ▶ Connected to a PC
 - ▶ Latency issues
- ▶ Easy of use
 - ▶ Inside-out tracking
 - ▶ Power consumption
- ▶ Quality content

Long battery life
Equipped with a **3200** mAh lithium polymer battery, can play about **3** hours.





CEVA Imaging & Vision

Industry Recognition



Linley Group

- ▶ CEVA-XM4 awarded Linley's "Best Processor IP" in 2015



Vision System Design

- ▶ CEVA-XM6 awarded "Innovator Gold Awards" in 2018



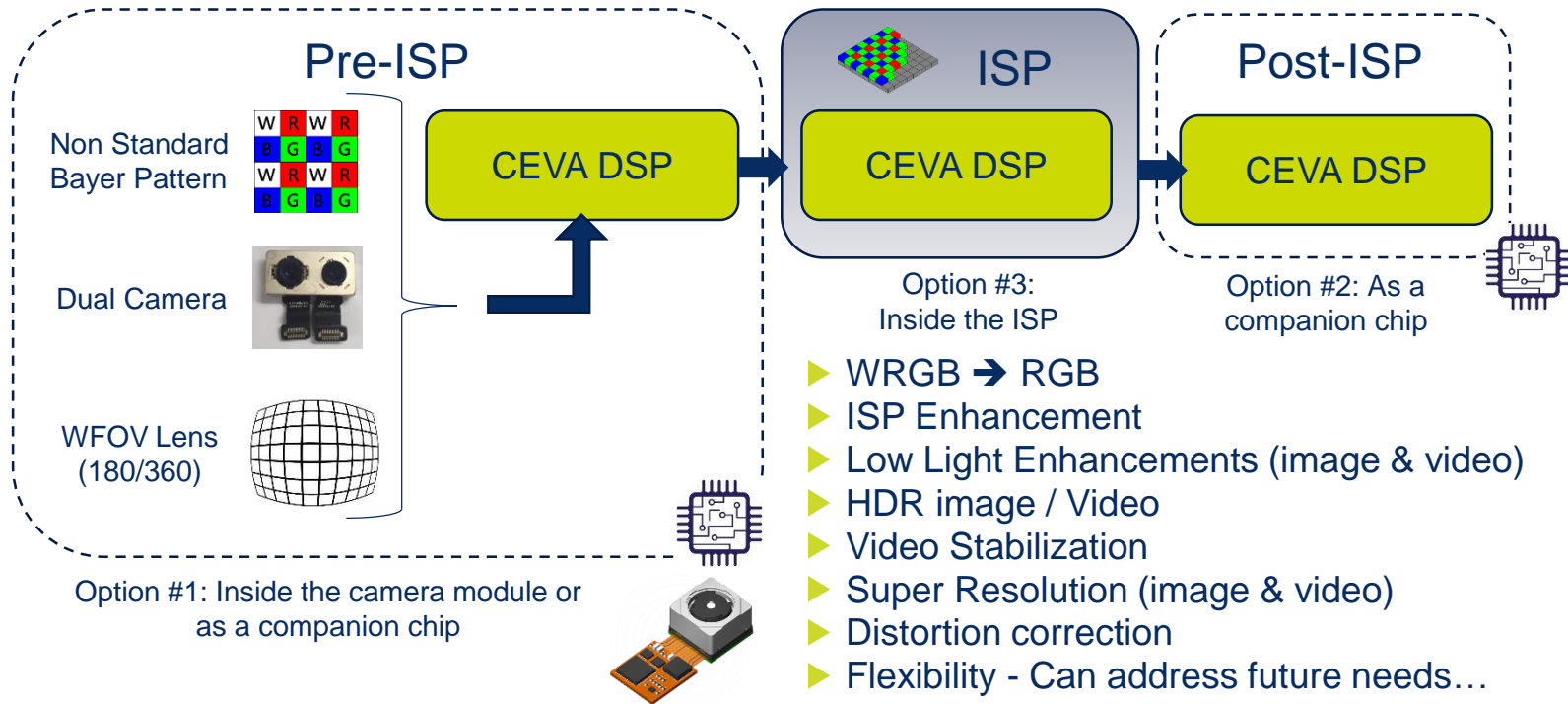
Enable Comprehensive Vision and AI Solutions



- ▶ Computational photography and computer vision applications, delivering a human-like visual perception
- ▶ Intelligent processing applications, delivering a human-like smart devices
- ▶ Enabling power-efficient, intelligent devices for a range of end markets, including mobile, consumer, automotive, industrial and IoT



CEVA Vision and Imaging DSP as 'Enabler' for Better Image and Video Quality



Rockchip RK1608



Technology Features

- ▶ Dual CEVA-XM4 @ 600MHz
- ▶ Frame based process, rather than line based in ISP
- ▶ Multi frame process, RAW domain, better quality than YUV domain
- ▶ Faster than AP process, 200ms process Multi frame de-noise
- ▶ No impact AF/AWB, just fine tune AE of ISP

http://www.rock-chips.com/a/en/News/Press_Releases/2017/0227/836.html

Rockchip

RK1608

Pre-ISP

Vision Coprocessor
Image Enhancement
Multi Camera Solution

Features

- Frame based process, rather than line based in ISP
- Multi camera process, RAW domain, better quality than YUV domain
- Expertise for image processing, much faster than AP
- Weak correlation with ISP, freely adapt to any platform

Application Feature

- Multi-frame de-noise
- Zig-Zag HDR processing for preview and capture
- HDR processing of multi-exposed image
- Depth map generation
- Super resolution
- Pseudo optical zooming

Rockchip
RK1608

Other Smartphone

RK1608 Smartphone

www.rock-chips.com

The slide features a dark blue background with a yellow and white curved graphic at the bottom. It includes the Rockchip logo, the product name 'RK1608', and the 'Pre-ISP' title. A list of features and application features is provided. At the bottom, two smartphone screens are shown side-by-side: the left one is labeled 'Other Smartphone' and shows a blurry image of a woman, while the right one is labeled 'RK1608 Smartphone' and shows a sharp, clear image of the same woman. The website 'www.rock-chips.com' is listed at the bottom right.

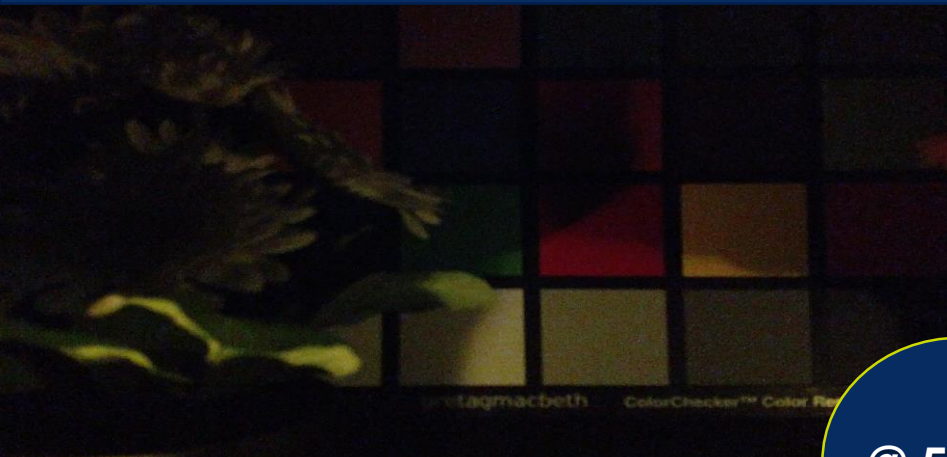


iPhone 7 Plus样张



Vivo X9s Plus样张

Motorola X



Galaxy S7



@ 5 LUX

iPhone 7 Plus



ASUS Zenfone 3 Zoom



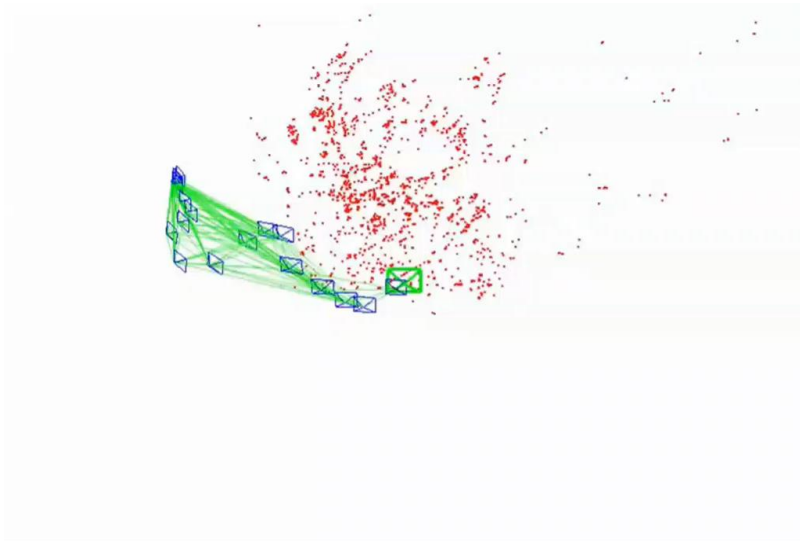


SLAM Technology



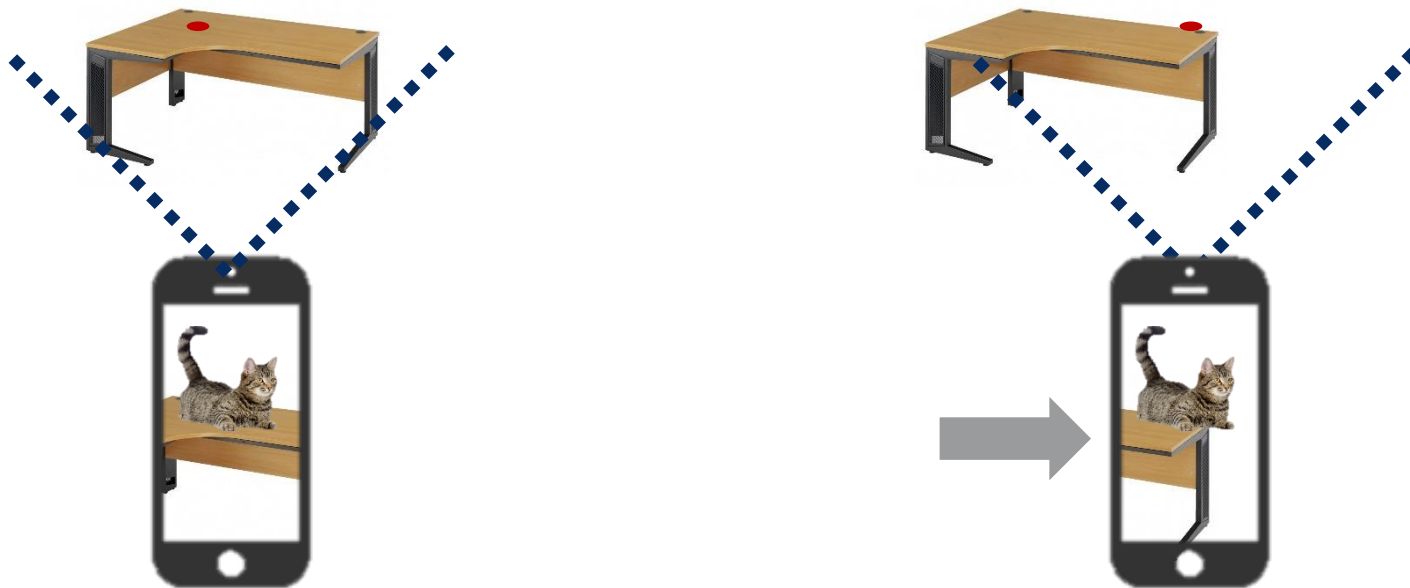
What is SLAM?

- ▶ Simultaneous Localization And Mapping
- ▶ Find sensor position in space (6DoF) while mapping the environment




SLAM Technology

- ▶ In order for computer vision application to relate to the real environment the device must find it's position in space accurately



Industry Using SLAM

- ▶ Mobile device localization
- ▶ Automotive
- ▶ Drones
- ▶ Enabler for AR/VR application
 - ▶ Apple's ARKit 
 - ▶ Google's ARCore  ARCore

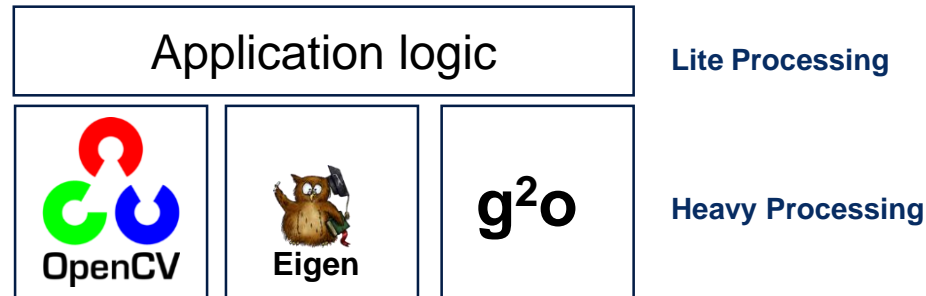
SLAM is an essential technology for AR to accurately position virtual objects in tracked scenes

SLAM Solutions

- ▶ Various visual SLAM solution vendors



- ▶ All share similar building blocks when it comes heavy processing
- ▶ Each vendor have it's own propriety high level logic and tuning



CEVA's SLAM SDK

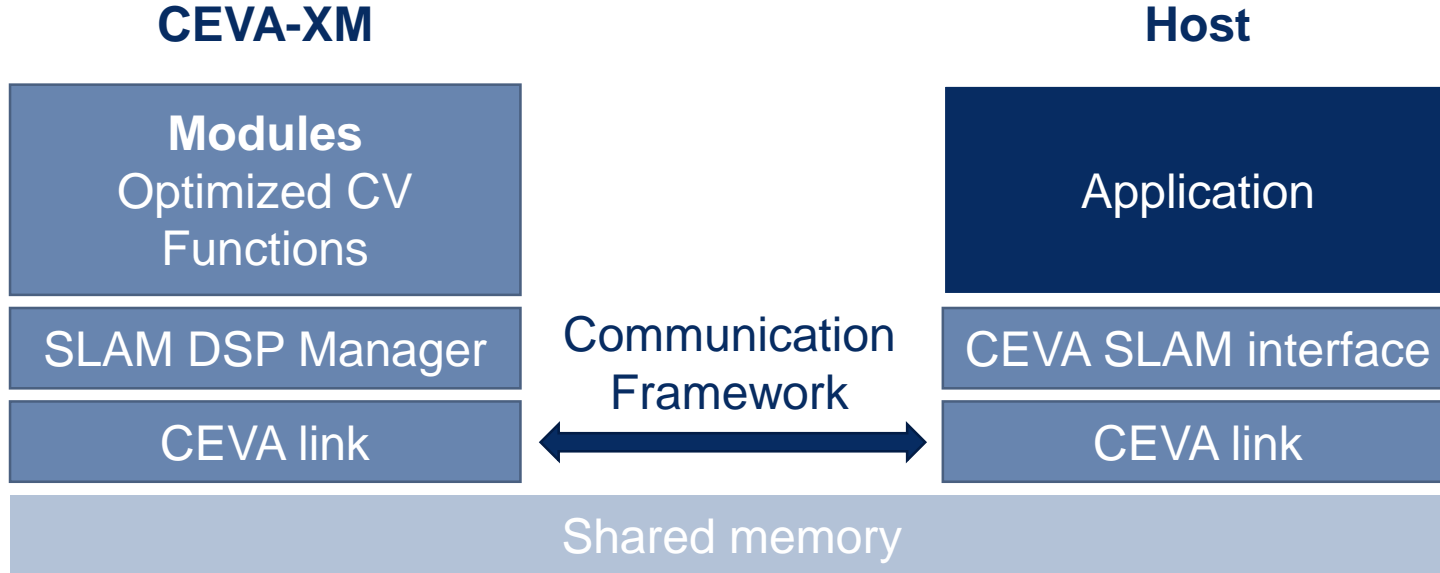


- ▶ Accelerate heavy processing using efficient vector DSP
- ▶ Easy seamless integration with standard APIs
- ▶ Generic modules supports various sensors
 - ▶ Mono, Stereo, TOF
- ▶ Feature set
 - ▶ Image processing
 - ▶ Feature detection, extraction and matching
 - ▶ 3D point processing
 - ▶ Complex math operation

CEVA's SLAM SDK - Integration

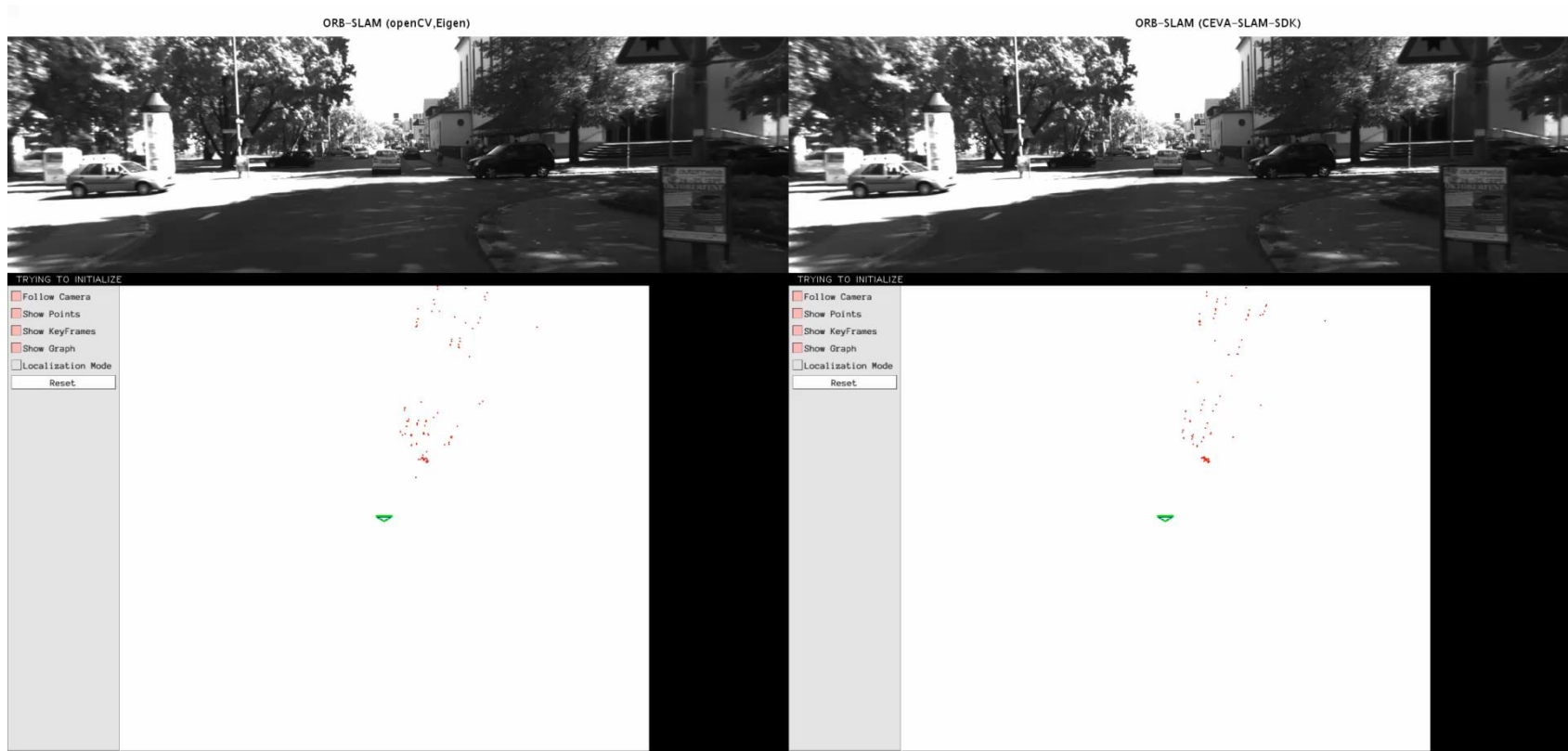


- ▶ Two main design goals:
 - ▶ Optimized CV functions
 - ▶ Easy integration with existing solutions – **Offload framework**



* Supplied by CEVA

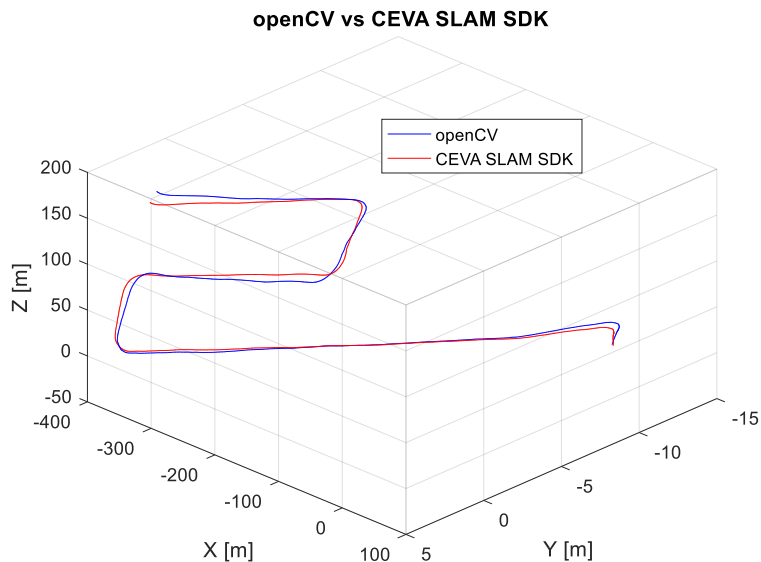
Example – ORB SLAM2



Example – ORB SLAM2

► Accuracy Analysis

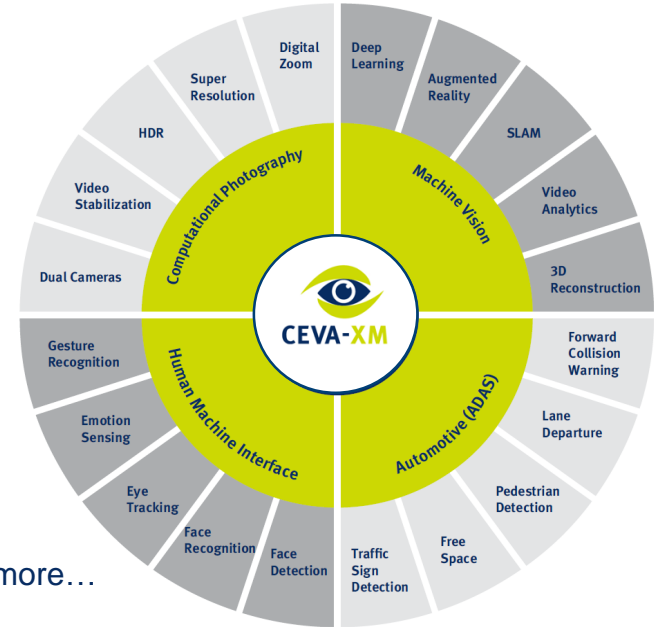
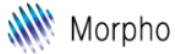
► Trajectory



► Error Statistics Analysis

Relative Error (% Of Range)	Open Source	CEVA SLAM-SDK
Mean	0.6	0.5
Median 50%	0.65	0.5
Median 90%	0.9	0.8

CEVA-XM is a Technology Enabler



And much more...

CEVA's Software Ecosystem Enable Fast Time-to-Market

Thank You



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